

the 3rd

global bridge Scholarship

Would you like to be a bridge between Cambodia and Japan?

This Scholarship was established to support those High school students who wish to learn at university by providing a subsidy to help cover the necessary tuition fees and living expenses. This Scholarship helps students to access educational opportunities while having a stable environment in which they may focus on their studies. We expect Scholarship students to make great contributions in both Cambodia and Japan in the future.

Scholarship type

Grant-type scholarship

Detail

- Amount : \$1,200 per year
- PaymentPeriod : Four years, from admission to graduation
- Number of recipients Up to ten students per year

Eligibility

Applicants should be Siem Reap High School students who wish to learn at university.

*Those who take the high school graduation exam in August 2020

Contact Email

cambodia-scholarship@globalbridge-hd.com

For more information

<https://globalbridge-hd.com/overseas/cambodia-scholarship/guidelines/>

Test day
June 3
2020

